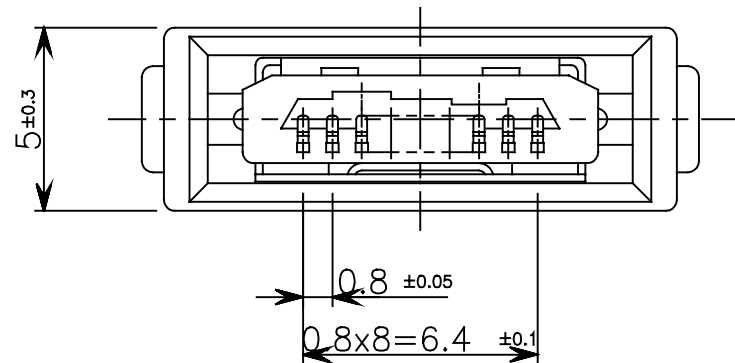
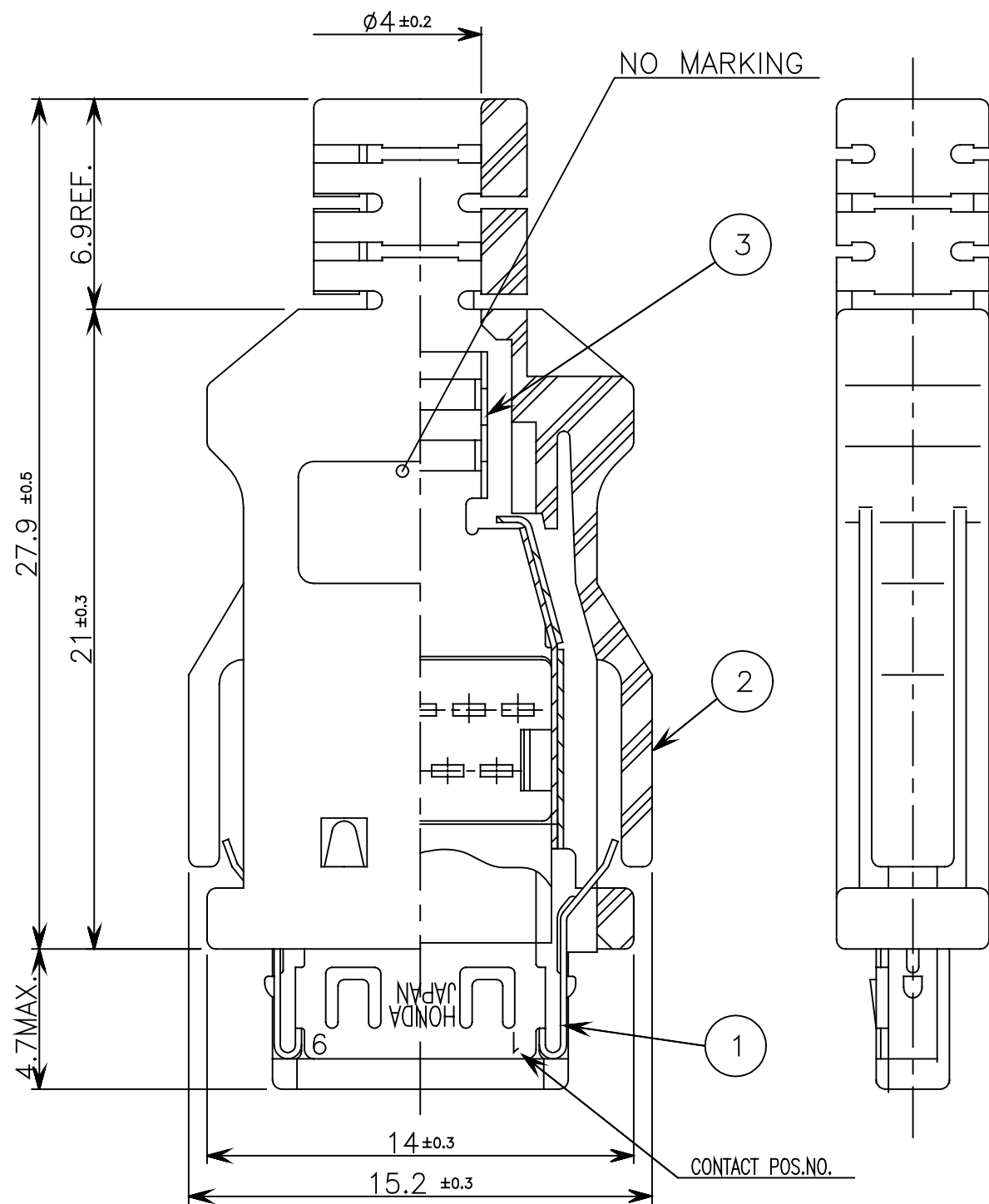
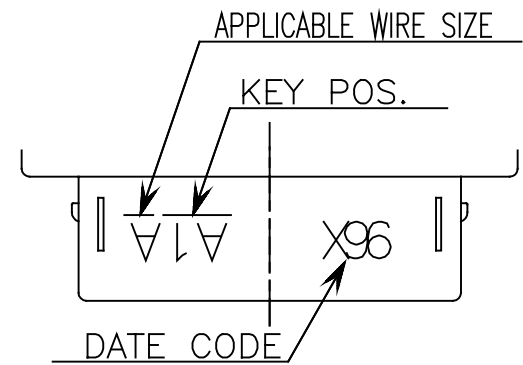
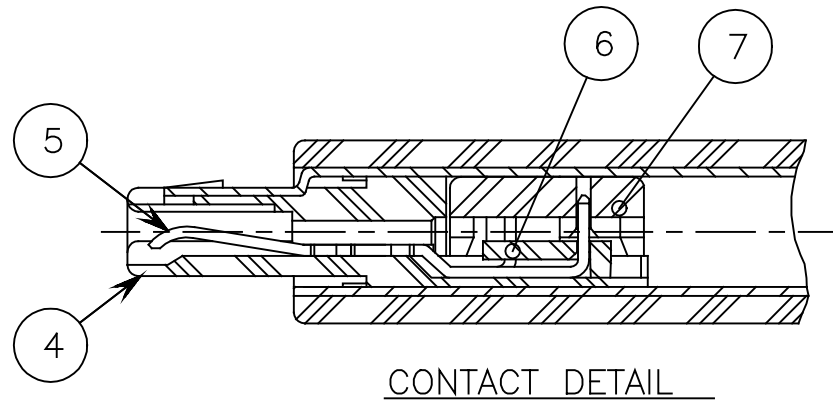




STANDARD KEY POS. (W/O KEY P/N:RMC-EB9F()-BSLA2N-MA)

△ PART NO.	KEY POS.	MARKING	MATING CONNECTOR △
RMC-EB9F()-BSLA2N-MA1	1	A1	RMC-E9MY-0M-MA2
RMC-EB9F()-BSLA2N-MA2	2	A2	RMC-E9MY-0M-MA1



NOTE 1.CONTACT PLATING
CONTACT AREA:GOLD 0.1μm MIN.,OVER Pd/Ni(9/1) 1μm MIN.
TERMINAL AREA:TIN LEAD ALL OVER Ni 1.27μm MIN.

2.APPLICABLE WIRE

CONNECTOR P/N	CORE SIZE	CORE JACKET O.D	MARKING
RMC-EB9FA-BSLA2N-MA()	28AWG(7/0.127)	0.45~0.58	A
RMC-EB9FB-BSLA2N-MA()	30AWG(7/0.102)	0.45~0.58	B

3.IDC WIRE ALIGNMENT TOOL P/N:FHAT-0008A

4.IDC CRIMPING TOOL P/N:FHPT-0007A

NOTE 5.SHIELD CRIMP TOOL

△CONNECTOR P/N	CRIMP TOOL P/N
RMC-EB9FA-BSLA2N-MA()	FHPT-0006A-B
RMC-EB9FB-BSLA2N-MA()	FHPT-0006A-B

7	CABLE HOUSING	PBT(GF)	1	——	UL94V-0 BLACK
6	SPACER	PBT(GF)	1	——	UL94V-0 BLACK
5	FEMALE CONTACT	PHOSPHOR BRONZE	9	SEE NOTE#1	——
4	INSULATOR	46NYLON(GF)	1	——	UL94V-0 BLACK
3	METAL COVER B	STAINLESS STEEL	1	——	——
2	MOLD COVER	△PBT(NON GF)	1	——	UL94V-0 BLACK
1	METAL COVER A	STAINLESS STEEL	1	——	——
NO.	PART NAME	MATERIAL	QTY	FINISH	NOTE

△	SEP.16 1998	K.Y	CHANGE P/N KEY IS MOLDING	3	METAL COVER B	STAINLESS STEEL	1	—	—	—
△	OCT.3 1996	K.Y	NEW REV. CHANGE MATERIAL AND PART NO.	2	MOLD COVER	△PBT(NON GF)	1	—	—	—
△	OCT.3 1996	K.Y	NEW REV. CHANGE MATERIAL AND PART NO.	1	METAL COVER A	STAINLESS STEEL	1	—	—	—
LTR.	DATE	BY	REV.	DESCRIPT	NO.	PART NAME	MATERIAL	QTY	FINISH	NOTE
DATE DEC.6 (1994)	SCALE 5/1	UNIT mm(INCH)	3RD . A . P	HONDA TSUSHIN KOGYO., LTD.						
DR	DE	CHK	CHK	APP.	NAME	PC CARD I/O FEMALE CONNECTOR 9POS. IDC WIRE TERMINATION				
					PART NO.	△△RMC-EB9F()-BSLA2N-MA()	REV. 2B			

RMC-EB9F()-BSLA2N-MA() EB